

$V_{RSM} = 100\text{ V}$, $I_{F(AV)} = 30\text{ A}$
Schottky Diode
FMEN-430A

Description

The FMEN-430A is a 100 V, 30 A Schottky diode that has the improved characteristics of V_F and I_R . These characteristics realize the improvement of power supply efficiency and the high frequency system.

Features

- V_{RSM} ----- 100 V
- $I_{F(AV)}$ ----- 30 A
- V_F ($I_F = 15\text{ A}$) ----- 0.81 V typ.
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

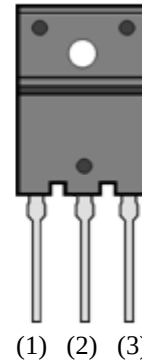
Applications

High speed switching applications as follows:

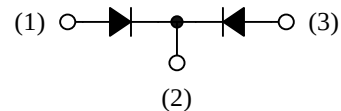
- DC-DC Converter
- Adapter

Package

TO3PF-3L



Not to scale



(1) Anode
(2) Cathode
(3) Anode

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25\text{ }^{\circ}\text{C}$

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V_{RSM}		100	V
Repetitive Peak Reverse Voltage	V_{RM}		100	V
Average Forward Current	$I_{F(AV)}$	See Figure 1 and Figure 2	30	A
Surge Forward Current	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	150	A
I^2t Limiting Value	I^2t	$1\text{ ms} \leq t \leq 10\text{ ms}$	112.5	A^2s
Junction Temperature	T_J		-40 to 150	$^{\circ}\text{C}$
Storage Temperature	T_{STG}		-40 to 150	$^{\circ}\text{C}$

Electrical Characteristics

Unless otherwise specified, $T_A = 25\text{ }^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop ⁽¹⁾	V_F	$I_F = 15\text{ A}$	—	0.81	0.85	V
Reverse Leakage Current ⁽¹⁾	I_R	$V_R = V_{RM}$	—	—	300	μA
Reverse Leakage Current under High Temperature ⁽¹⁾	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150\text{ }^{\circ}\text{C}$	—	—	150	mA
Thermal Resistance ⁽²⁾	$R_{th(J-C)}$		—	—	2.0	$^{\circ}\text{C/W}$

Mechanical Characteristics

Parameter	Conditions	Min.	Typ.	Max.	Unit
Heatsink Mounting Screw Torque		0.686	—	0.882	$\text{N}\cdot\text{m}$

⁽¹⁾ The rating of one chip.

⁽²⁾ $R_{th(J-C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Rating and Characteristic Curves

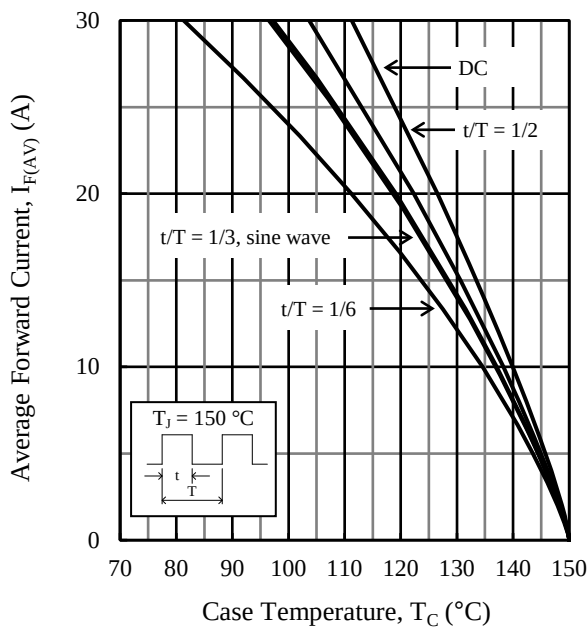


Figure 1. Typical Characteristics: $I_{F(AV)}$ vs. T_C ($V_R = 0$ V)

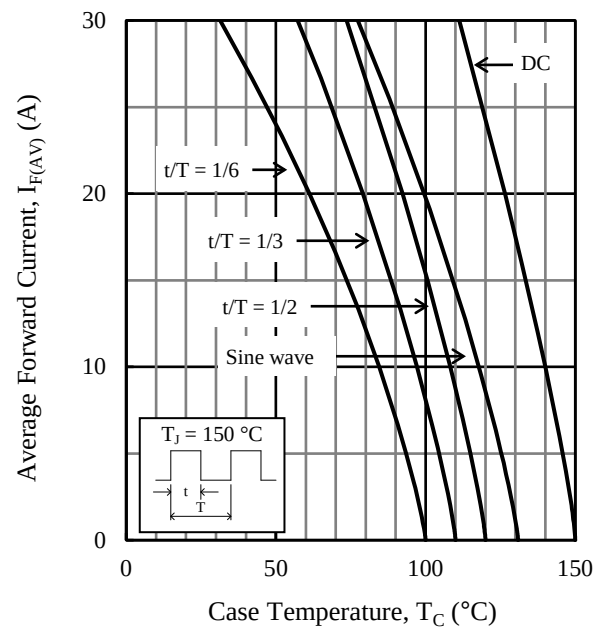


Figure 2. Typical Characteristics: $I_{F(AV)}$ vs. T_C ($V_R = 100$ V)

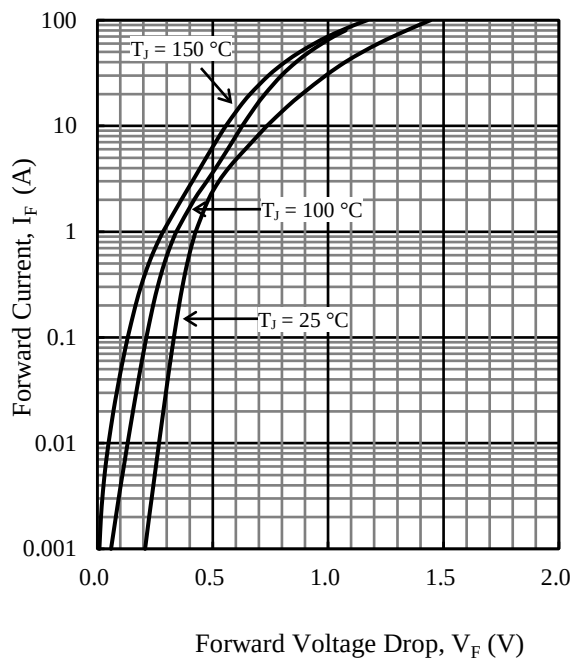


Figure 3. Typical Characteristics: I_F vs. V_F

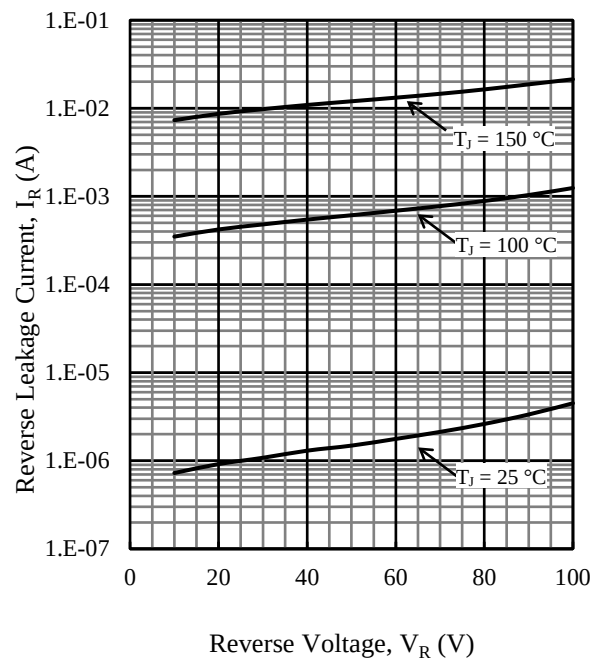
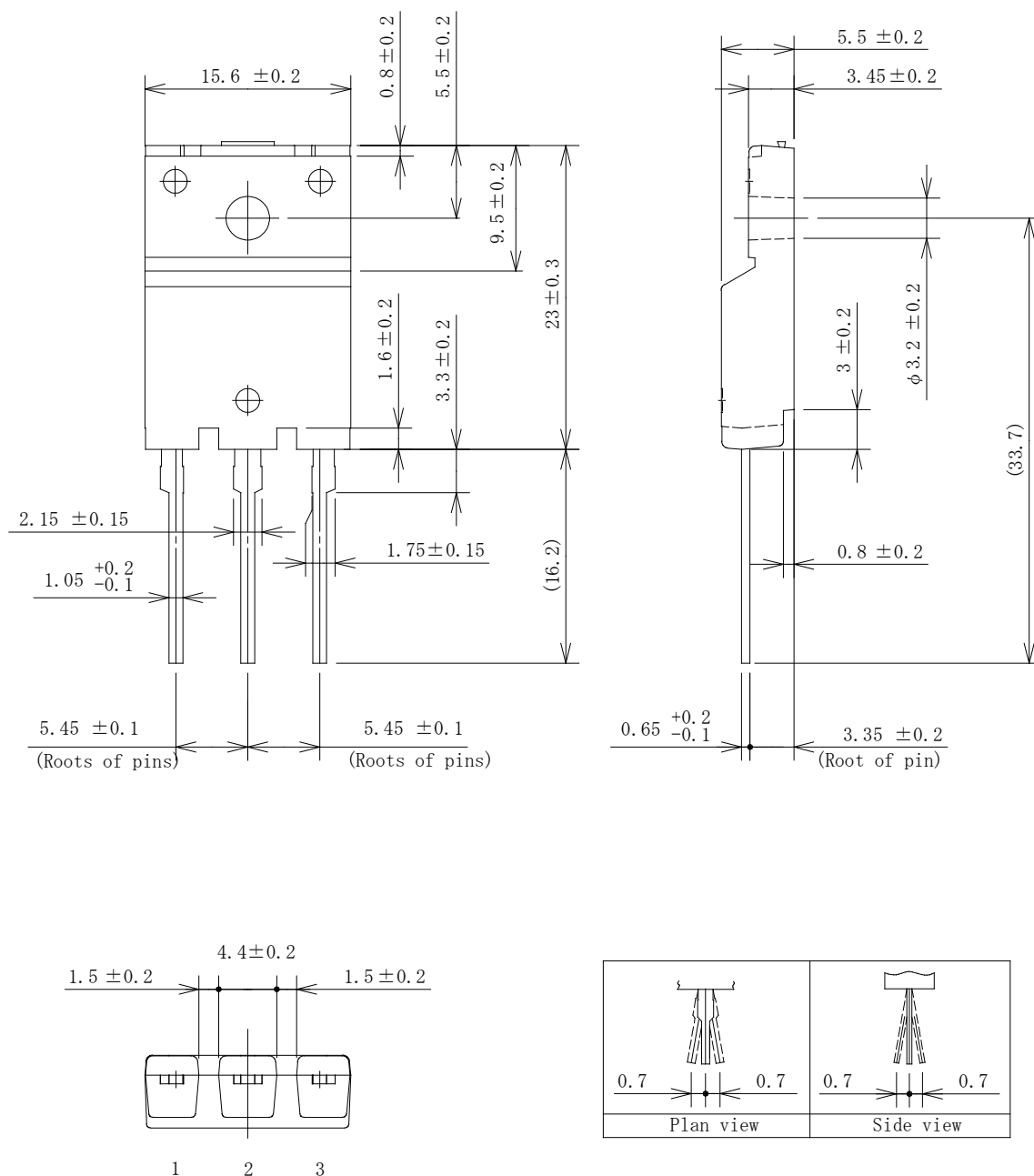


Figure 4. Typical Characteristics: I_R vs. V_R

Physical Dimensions

• TO3PF-3L



NOTES:

- Dimensions in millimeters
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:
 Flow: 260 ± 5 °C / 10 ± 1 s, 2 times
 Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time
 Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

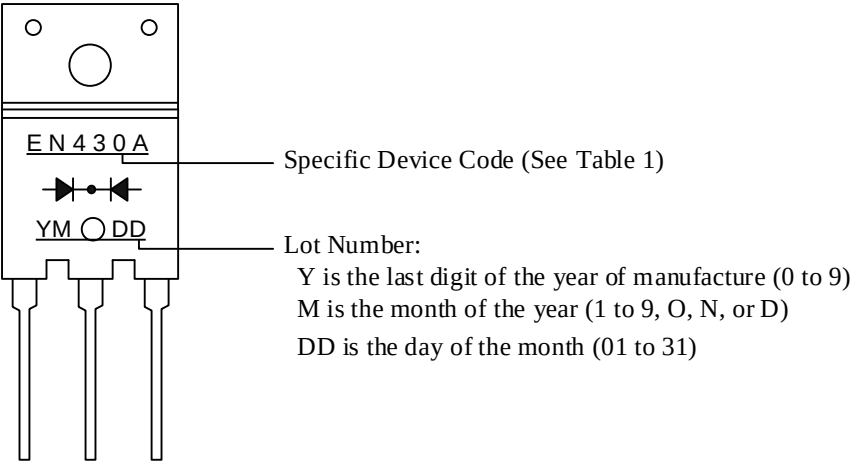


Table 1. Specific Device Code

Specific Device Code	Part Number
EN430A	FMEN-430A

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DSGN-CEZ-16003